

## **IEC QUALITY ASSESSMENT SYSTEM (IECQ)**

## covering Electronic Components, Assemblies, Related Materials and Processes

For rules and details of the IECQ visit www.iecq.org

BS CECC 23300-003

## Schedule of Scope to Certificate of Approval

## **Approved Process - Capability Approval**

IECQ Certificate No.: IECQ-C BSI 14.0008

CB Certificate No.: E093/CA

Schedule Number: IECQ-C BSI 14.0008-S Rev No.: 4 Revision Date: 2016/04/26 Page 1 of 1

**Board Types:** Rigid Multilayer with plated-through holes

Rigid Double sided with plated-through holes

Rigid Single and double sided with plain holes

BS CECC 23200-003

BS CECC 23100-003

Base Materials: Epoxide Woven Glass

Ceramic filled thermoset/woven glass

Board Size: 520 mm x 300 mm Maximum BS EN 123 300

580 mm x 480 mm Maximum BS EN 123 200, BS EN 123 100 610 mm x 510 mm Maximum BS EN 123 200, BS EN 123 100

**Conductors:** Minimum Width: 10 mm  $\pm 0.02$  mm

Minimum Spacing: 10 mm  $\pm 0.02$  mm

Number of Layers 1 - 14 Maximum

Plated-through Hole

Diameter:

0.25 mm drilled hole (0.15 mm finished hole)

**Aspect Ratio:** 9.6 : 1 Maximum

**Finishes:** Hot Air Solder Leveled SnPb<sup>(1)</sup>

Lead Free (Pb-Free) Hot Air Solder Levelled Tin<sup>(1)</sup>

Immersion Silver<sup>(2)</sup>

Electroless Nickel/Immersion Gold (2)

Liquid Photoimagable solder Resist (Thermal Cure)

Marking Inks:

Screen Printed UV Cure

Liquid Photoimageable Ident ink (Thermal Cure)

Ink Jet applied UV Cure

**Additional:** Gold Edge contacts: 2.5 microns Gold on 3.0 - 5.0 microns Nickel over Copper<sup>(3)</sup>

It may not be possible to achieve all the limits of the capability in combination. Such combinations are determined by the agreed customer detail specification for the printed circuit board ordered.

Meets the requirement for Solderability after accelerated ageing using Activated Flux

Meets the requirements for Solderability using Activated Flux

Sub-contracted Process for Edge contacts of assessed porosity

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